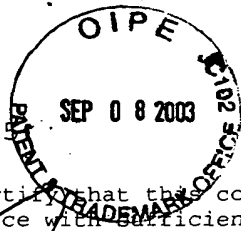


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BOX AF

I hereby certify that the correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to the Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450:

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Barbara Vasquez et al.
Applic. No. : 10/062,942
Filed : January 31, 2002
Title : Method of Applying a Bottom Surface
Protective Coating to a Wafer, and Wafer
Dicing Method
Examiner : Angel Roman
Group Art Unit : 2812

A M E N D M E N T under 37 C.F.R. § 1.116

BOX AF
Hon. Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

S i r :

Responsive to the final Office action dated June 6, 2003

kindly amend the above-identified application as follows: